

Solder balls, Sn63Pb37, 300 µm



Solder balls for CSP, contains lead, 300 µm
 Alloy, Sn63Pb37
 PU = 50,000 pcs

item number	WL26306
model	HT00.1005 / VD90.5005
manufacturer	WEIDINGER
manufacturer item number	VD90.5005
order unit	1 PU
content unit	50000 piece